MOSFETs Silicon N-channel MOS (U-MOSIV)

TPCC8007

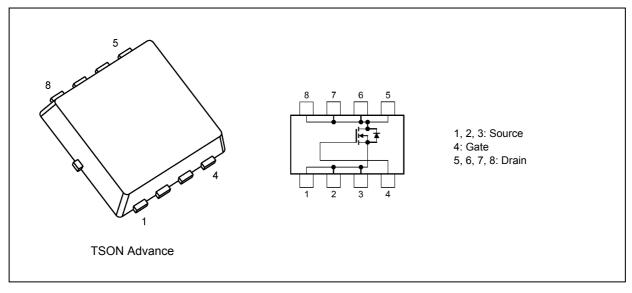
1. Applications

- Notebook PCs
- Mobile Handsets

2. Features

- (1) Small footprint due to a small and thin package
- (2) Low drain-source on-resistance: $R_{DS(ON)} = 3.5 \text{ m}\Omega \text{ (typ.)} (V_{GS} = 4.5 \text{ V})$
- (3) Low leakage current: $I_{DSS} = 10 \ \mu A \ (max) \ (V_{DS} = 20 \ V)$
- (4) Enhancement mode: V_{th} = 0.5 to 1.2 V (V_{DS} = 10 V, I_D = 1 mA)

3. Packaging and Internal Circuit



4. Absolute Maximum Ratings (Note) (Ta = 25°C unless otherwise specified)

Characteris	Symbol	Rating	Unit		
Drain-source voltage			V _{DSS}	20	V
Gate-source voltage			V _{GSS}	±12	
Drain current (DC)		(Note 1)	Ι _D	27	Α
Drain current (pulsed)		(Note 1)	I _{DP}	81	
Power dissipation	(T _c = 25°C)		PD	30	W
Power dissipation	(t = 10 s)	(Note 2)	PD	1.9	W
Power dissipation	(t = 10 s)	(Note 3)	PD	0.7	W
Single-pulse avalanche energy		(Note 4)	E _{AS}	190	mJ
Avalanche current			I _{AR}	27	A
Channel temperature			T _{ch}	150	°C
Storage temperature			T _{stg}	-55 to 150	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

5. Thermal Characteristics

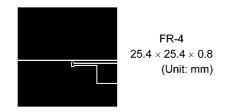
Characteristics			Symbol	Max	Unit
Channel-to-case thermal resistance	(T _c = 25°C)		R _{th(ch-c)}	4.1	°C/W
Channel-to-ambient thermal resistance	(t = 10 s)	(Note 2)	R _{th(ch-a)}	65.7	°C/W
Channel-to-ambient thermal resistance	(t = 10 s)	(Note 3)	R _{th(ch-a)}	178	°C/W

Note 1: Ensure that the channel temperature does not exceed 150°C.

Note 2: Device mounted on a glass-epoxy board (a), Figure 5.1

Note 3: Device mounted on a glass-epoxy board (b), Figure 5.2

Note 4: V_DD = 16 V, T_ch = 25°C (initial), L = 0.2 mH, R_G = 25 Ω , I_AR = 27 A



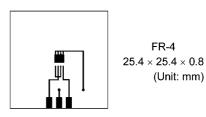


Fig. 5.1 Device Mounted on a Glass-Epoxy Board (a)



Note: This transistor is sensitive to electrostatic discharge and should be handled with care.

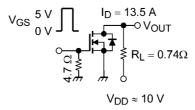
6. Electrical Characteristics

6.1. Static Characteristics (Ta = 25°C unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage current	I _{GSS}	V _{GS} = ±12 V, V _{DS} = 0 V	_		±0.1	μΑ
Drain cut-off current	I _{DSS}	V _{DS} = 20 V, V _{GS} = 0 V	_		10	
Drain-source breakdown voltage	V _{(BR)DSS}	I _D = 10 mA, V _{GS} = 0 V	20		_	V
	V _{(BR)DSX}	I _D = 10 mA, V _{GS} = -12 V	8		_	
Gate threshold voltage	V _{th}	V _{DS} = 10 V, I _D = 1 mA	0.5		1.2	
Drain-source on-resistance	R _{DS(ON)}	V _{GS} = 2.5 V, I _D = 13.5 A	_	6.2	8.7	mΩ
		V _{GS} = 4.5 V, I _D = 13.5 A	_	3.5	4.6	

6.2. Dynamic Characteristics ($T_a = 25^{\circ}C$ unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Input capacitance	C _{iss}	V _{DS} = 10 V, V _{GS} = 0 V, f = 1 MHz		1870	_	pF
Reverse transfer capacitance	C _{rss}			480	_	
Output capacitance	C _{oss}			660	_	
Switching time (rise time)	t _r	See Figure 6.2.1.		8.6		ns
Switching time (turn-on time)	t _{on}			16	_	
Switching time (fall time)	t _f]		20	_	
Switching time (turn-off time)	t _{off}]	_	58	_	



Duty \leq 1%, $t_W =$ 10 μs

Fig. 6.2.1 Switching Time Test Circuit

6.3. Gate Charge Characteristics ($T_a = 25^{\circ}C$ unless otherwise specified)

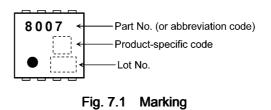
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Total gate charge (gate-source plus gate-drain)	Qg	$V_{DD} \approx 16 \text{ V}, \text{ V}_{GS} = 5 \text{ V}, \text{ I}_{D} = 27 \text{ A}$	_	26	—	nC
Gate-source charge 1	Q _{gs1}			5	_	
Gate-drain charge	Q _{gd}		_	12	_	

6.4. Source-Drain Characteristics ($T_a = 25^{\circ}C$ unless otherwise specified)

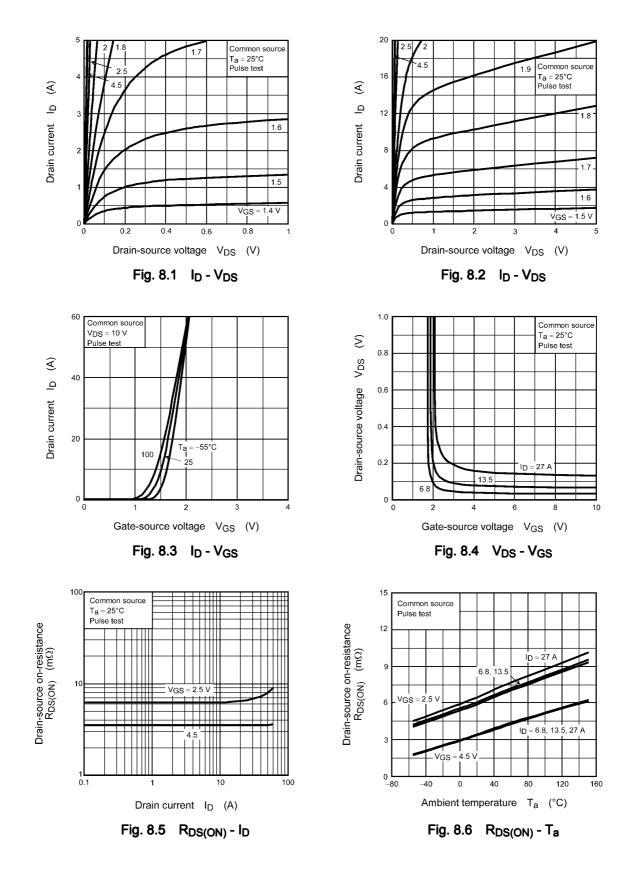
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Reverse drain current (pulsed) (Note	i) I _{DRP}	—	_	—	81	А
Diode forward voltage	V _{DSF}	I _{DR} = 27 A, V _{GS} = 0 V	_		-1.2	V

Note 5: Ensure that the channel temperature does not exceed 150°C.

7. Marking



8. Characteristics Curves (Note)



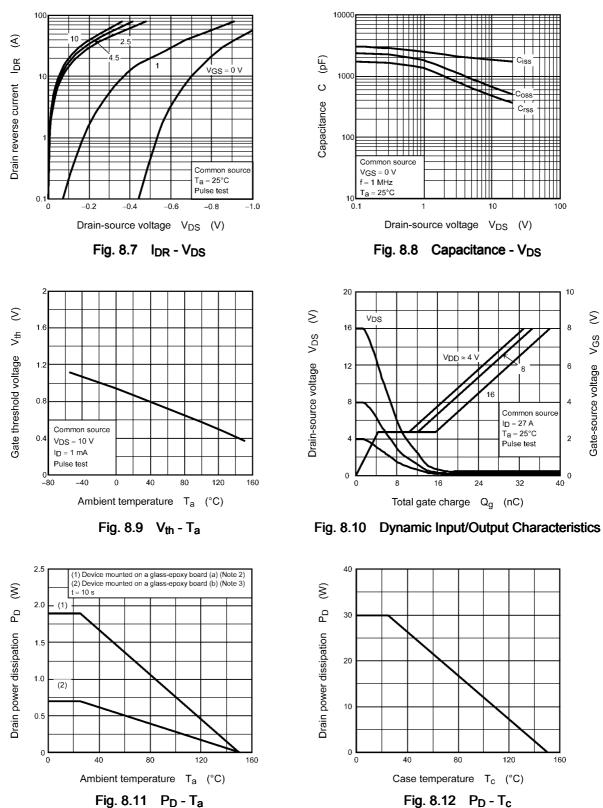
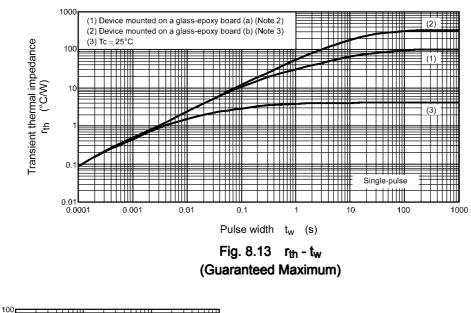
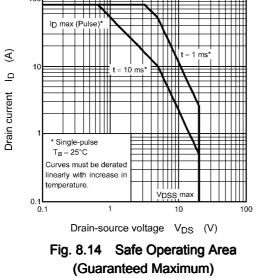


Fig. 8.11 P_D - T_a (Guaranteed Maximum)

(Guaranteed Maximum)



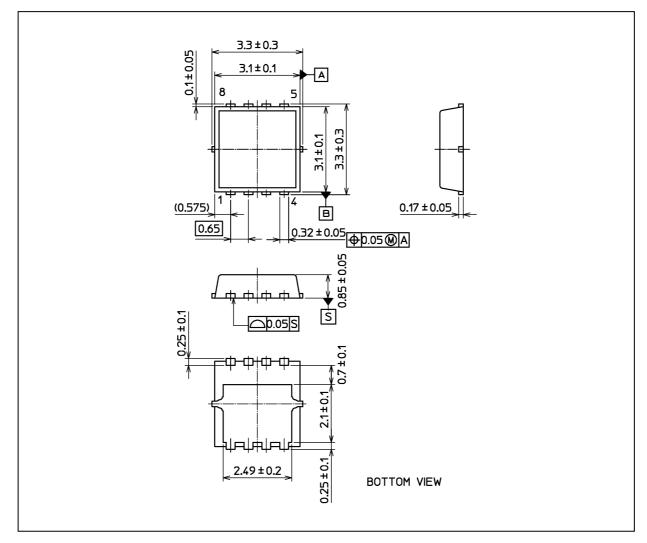


Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

Package Dimensions

Unit: mm

TPCC8007



Weight: 0.02 g (typ.)

Package Name(s)
TOSHIBA: 2-3X1S
Nickname: TSON Advance

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